

Technical Data Sheet 0805 Package Chip LED (0.8mm Height)

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant

version

Descriptions

- The 17-225 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

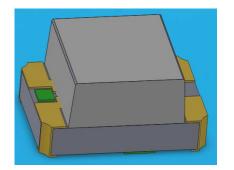
Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Chip		F '44 1 C 1	D : C I	
Туре	Material	Emitted Color	Resin Color	
G6	AlGaInP	Brilliant Yellow Green	W. Cl	
S2	AlGaInP	Brilliant Orange	Water Clear	

17-225/G6S2C-A30/2T

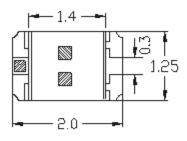


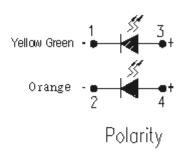
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Device No.:DSE-0003192 Prepared date:19-Jul-2012 Prepared by:Shen Jianhao



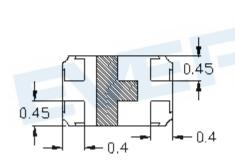
Package Outline Dimensions

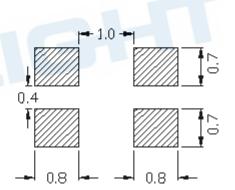






For reflow soldering (propose)





Note: The tolerances unless mentioned are ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit		
Reverse Voltage	VR	5	V		
Forward Current	IF	25	mA		
Peak Forward Current (Duty 1/10 @1KHz)	IFP	G6:60 S2:60	mA		
Power Dissipation	Pd	G6:60 S2:60	mW		
Electrostatic Discharge(HBM)	ESD	G6:2000 S2:2000	V		
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$		
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}$ C		
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.			

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Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	G6 S2	36.0 112.0		90.0 285.0	mcd	
Viewing Angle	2 0 1/2			130		deg	
Peak Wavelength	λ _P	G6 S2		575 611		nm	
Dominant Wavelength	λd	G6 S2		573 605		nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ	G6 S2		20 17		nm	
Forward Voltage	VF	G6 S2	1.7 1.7	2.0 2.0	2.4	V	
Reverse Current	IR	G6 S2	51	10	10 10	μΑ	V _R =5V

Notes:

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1.Tolerance of Luminous Intensity ±11%

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Bin Range Of Luminous Intensity

G6

Bin	Min	Max	Unit	Condition
1	36.0	57.0	1	1 20 4
2	57.0	90.0	mcd	$I_F=20\text{mA}$

S2

Bin	Min	Max	Unit	Condition	
R	112	180	1	I 20 A	
S	180	285	mcd	$I_F=20mA$	

Notes:

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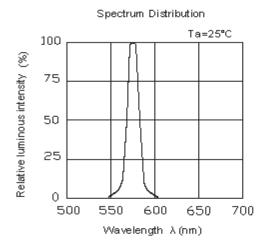
1.Tolerance of Luminous Intensity ±11% EXERLIGATI

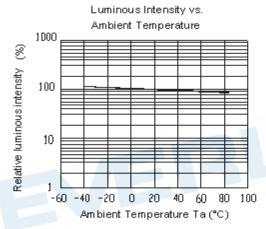
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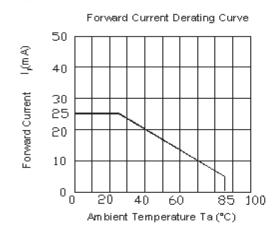
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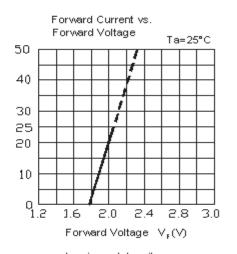


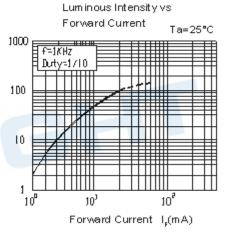
Typical Electro-Optical Characteristics Curves G6

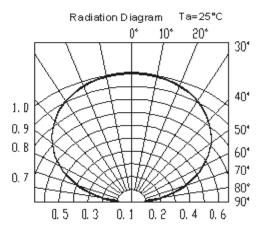












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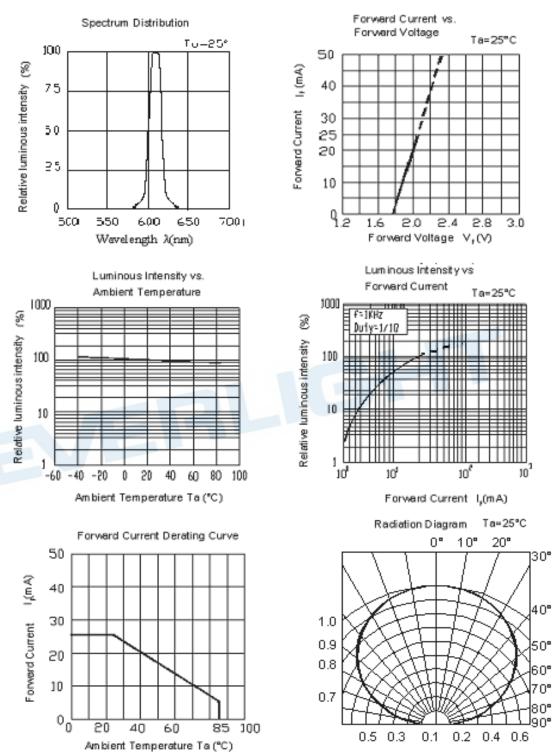
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Typical Electro-Optical Characteristics Curves S2



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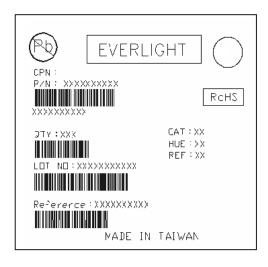


Label explanation

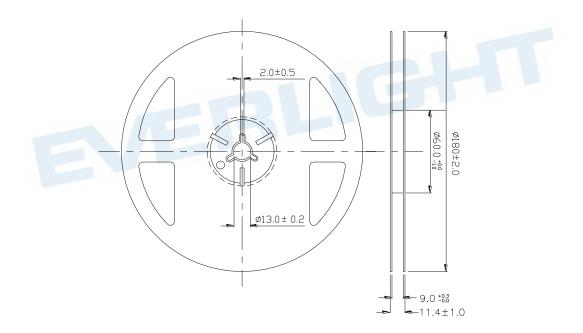
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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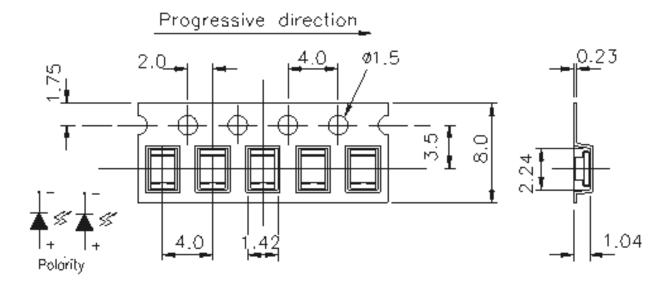
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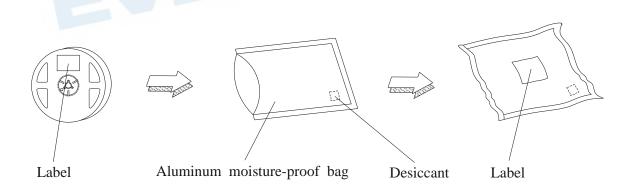


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85% RH	1000 Hrs.	22 PCS.	0/1

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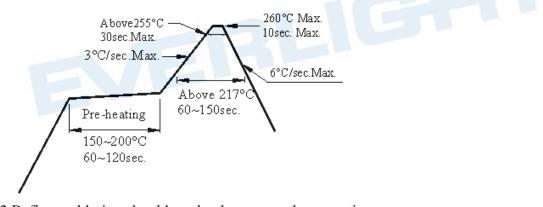
Precautions For Use

Over-current-proof
 Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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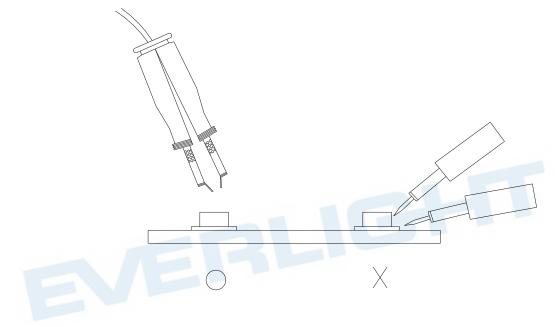


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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